

HALT/HASS for Pixel Modules

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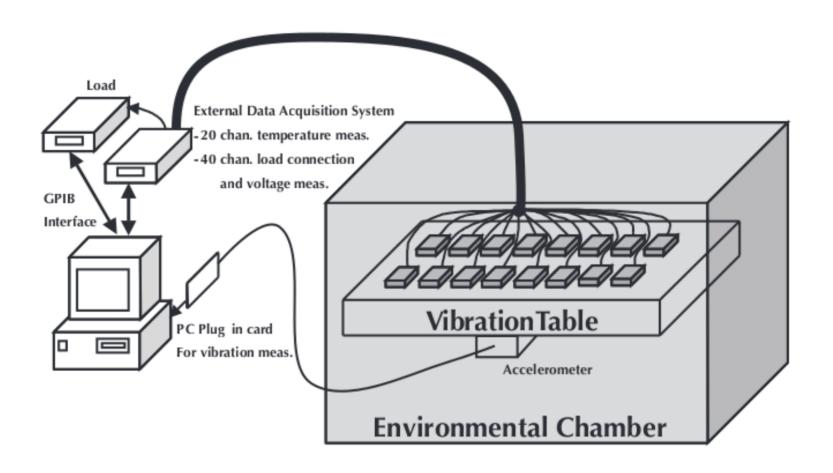
What is HALT/HASS

- HALT- Highly Accelerated Lifetime Testing
- HASS- Highly Accelerated Stress Screening

HALT is a step by step stress process
 performed during a product's prototype phase
 that determines a product's operating limits,
 identifies design weaknesses and identifies
 problems with components

- A test sample is subjected to progressively higher stress levels
 - Thermal steps
 - Rapid temperature changes (Thermal Shock)
 - Vibration
 - Combination of Vibration and Thermal
- Goal is to find latent, inherent defects in the design at both the component level and in the manufacturing process

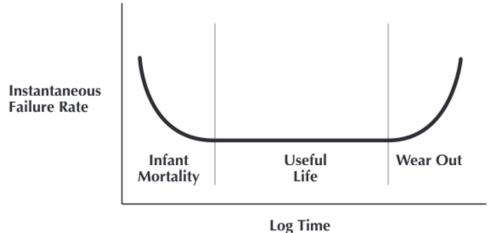
Typical HALT/HASS system



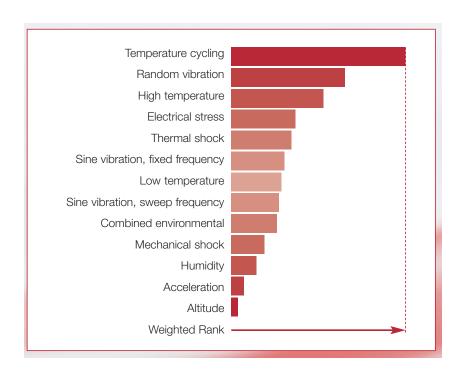
- Beyond finding defects, HALT stresses product to failure
- Robustness of design and margin above products intended operating level are determined.
- HALT is not a pass/fail test
- It is a process of understanding the products limitations and design optimization

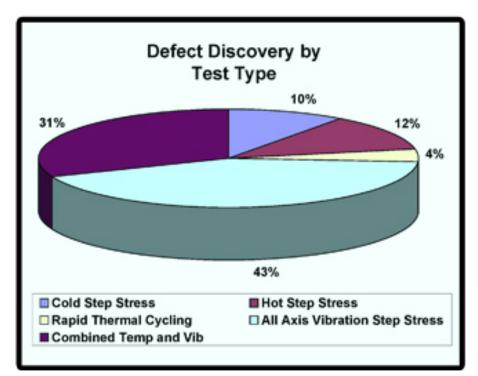
- Successful when failures produced, cause is understood, corrections are implemented and product's limits are understood and expanded
- Information learned during HALT process is used to develop HASS screening for monitoring issues in the manufacturing process.

- Can detect failures with small number of samples (~4), very quickly (~ 1 week)
- Goal is to improve lifetime of device under routine operation



Typical discovery of defects due to different stresses



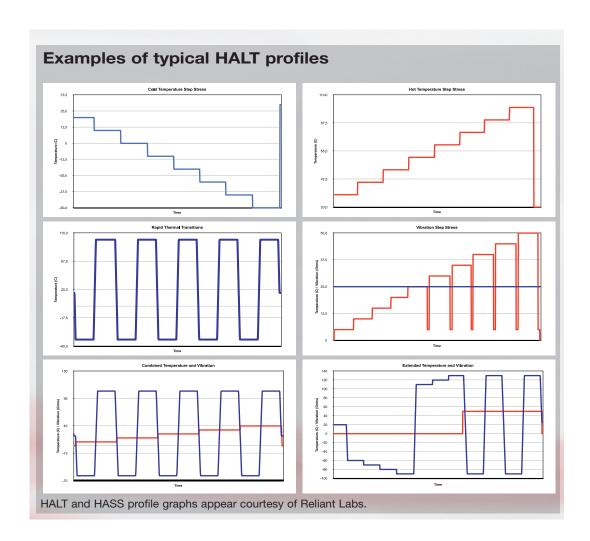


Cold or Hot step stresses in 10 C steps

5 thermal cycles with thermal changes of 50 C per minute. (Thermal Shock)

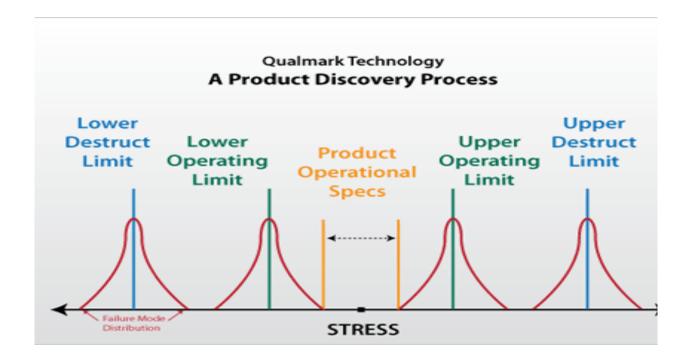
Step stress vibration in 5 gRMS increments

Combination of thermal and vibration stresses



- When failure occurs, test is stopped and failure mode and stress level is recorded
- If fixable, temporary fix is implemented and test continues to higher stress levels to uncover more failures
- HALT testing stops when test equipment limits are met, multiple failures occur in rapid succession with small increases in the stress level, or when maximum level of the materials/ technology is reached

- Provides operating limits and may provide destruct limits
- Operational limits is defined as the stress necessary to cause a malfunction, but product returns to normal operation when stress removed
- Destruct limit causes permanent failure



HASS

- Post production process that can be performed on 100% of product or a partial sample
- Main goal is to precipitate and detect hidden or latent failures
- Verify products in production
- Stress levels less than those in HALT
- More severe than anticipated in actual service
- Use enough stress to find faults, but not enough to remove a significant amount of product's lifetime
- Pass/fail test

HASS benefits

- Precipitates hidden or latent failures caused by poor manufacturing process
- Verifies integrity of mechanical components
- Detects changes in components/processes
- Exposes process related variations in manufacturing

Some Energy Industry Customers

















Some Electronics Customers

























Aerospace





THALES















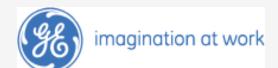
Medical



LOCKHEED MARTIN

We never forget who we're working for *

BAE SYSTEMS





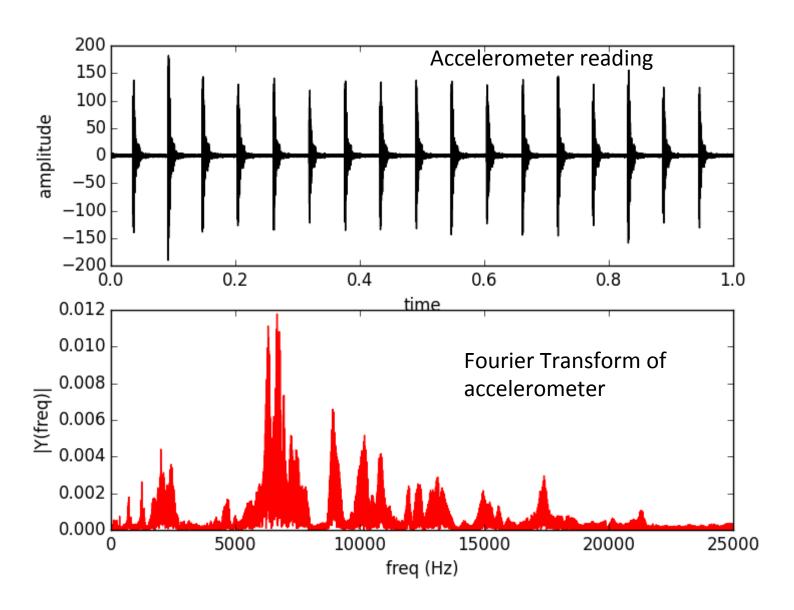
HALT HASS for pixels

- Proposal is to perform HALT/HASS on pixel modules to ensure they operate properly during the lifetime of the experiment
- Never been implemented in HEP experiments before but due to complexity of detectors and inability to access pixel detector it is imperative that all designs/components meet specifications
- HALT/HASS is an inexpensive and time effective method to help ensure robustness of detector design
- Commercial HALT/HASS systems cost ~ \$65K-\$100K for a small system.
- Need 1 HALT system, but will need many HASS systems if wishing to test all production modules prior to installation
- Therefore we are building our own HALT/HASS system at OU

OU HALT system

- Environmental chamber with a temperature range of -50 C -150 C. We are able to control chamber with a GUI to provide the necessary temperature stepping
- Vibration table. Single pneumatic hammer currently implemented provides a range of gRMS from 10-80 gRMS.
- Readout consisting of 3 accelerometers to measure x,y,z acceleration up to 50Khz
- Jig to hold module

Some initial plots from OU system



Under development

- gRMS controlled by air pressure/flow.
 Currently writing code to control air pressure/flow using computer controlled air regulator to precisely control gRMS
- Adding in additional pneumatic actuators to allow more control over vibrations
- Module Readout: Investigating USBPIX